

## MS D50N03

## N-Channel Logic Level Enhancement Mode Power MOSFET

### **Description**

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low rDS(on) and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

#### **Features**

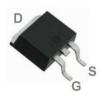
- VDS=30V, ID=50A, RDS(ON)=9m $\Omega$
- · Low Gate Charge
- · Repetitive Avalanche Rated
- · Simple Drive Requirement
- · Fast Switching Characteristic
- · RoHS compliant package

Package type: TO-252

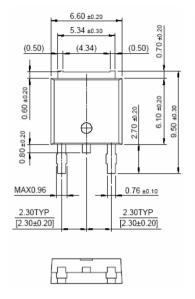
### **Packing & Order Information**

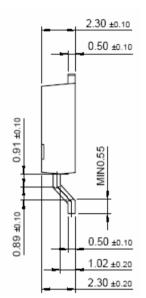
Part No./ T: 2,500/Reel

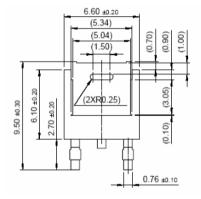
Part No./ R: 80/Tube, 4,000/Box



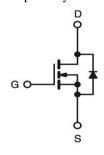








#### Graphic symbol



### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

| Absolute Maximum Ratings (Tc=25°C unless otherwise noted) |                                     |       |      |  |  |  |
|---|-------------------------------------|-------|------|--|--|--|
| Symbol  | Parameter                           | Value | Unit |  |  |  |
| $V_{DS}$  | Drain-Source Voltage                | 30    | V    |  |  |  |
| $V_{GS}$  | Gate-Source Voltage                 | ±30   | V    |  |  |  |
| $I_D$   | Continuous Drain Current @ TC=25°C  | 50    | A    |  |  |  |
|   | Continuous Drain Current @ TC=100°C | 35    | A    |  |  |  |



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|---|---|-------------|------|--|--|--|
| Symbol  | Parameter   | Value       | Unit |  |  |  |
| $I_{DM}*1$  | Pulsed Drain Current  | 140         | A    |  |  |  |
| I <sub>AS</sub>   | Avalanche Current   | 37.5        | A    |  |  |  |
| Eas   | Avalanche Energy @ L=0.1mH , ID = 37.5 A , Rg = 25 $\Omega$ | 70          | mJ   |  |  |  |
| E <sub>AR</sub> *2  | Repetitive Avalanche Energy @ L=0.05mH                      | 15          | mJ   |  |  |  |
| $P_D$   | Power Dissipation (TC=25°C)                                 | 60          | W    |  |  |  |
|   | Power Dissipation (TC=100°C)                                | 32          | W    |  |  |  |
| T <sub>J</sub> /T <sub>STG</sub>                          | Operating Junction and Storage Temperature                  | -55 to +150 | °C   |  |  |  |

#### Note:

100% UIS testing in condition of VD=15V, L=0.1mH, VG=10V, IL=25A, Rated VDS=25V N-CH

\*1. Pulse width limited by maximum junction temperature

<sup>\*2.</sup> Duty cycle≤1%

| Thermal Characteristics (Tc=25°C unless otherwise noted) |                            |         |       |  |  |  |
|--|----------------------------|---------|-------|--|--|--|
| Symbol   | Parameter                  | Maximum | Units |  |  |  |
| Rthjc  | Typical thermal resistance | 2.5     | °C/W  |  |  |  |
| RөлA   | Typical thermal resistance | 75      | C/W   |  |  |  |

| Static Characteristics |   |     |      |      |       |
|------------------------|---|-----|------|------|-------|
| Symbol                 | Test Conditions   | Min | Тур. | Max. | Units |
| $ m V_{GS}$            | $V_{\mathrm{DS}} = V_{\mathrm{GS}}, \ I_D = 250 \mu A$                          | 1.0 | 1.7  | 3.0  | V     |
| *R <sub>DS(ON)</sub>   | $V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$                                     |     | 75   | 9    | mΩ    |
| NDS(ON)                | $V_{GS} = 5 \text{ V}$ , $I_D = 20 \text{ A}$                                   |     | 12   | 15   |       |
| $BV_{DSS}$             | $V_{GS} = 0 \ V \ , \ I_D = 250 \ \mu A$  | 30  |      |      | V     |
| $I_{DSS}$              | $V_{DS} = 24 V, V_{GS} = 0 V$   |     |      | 1    | uA    |
| 108.8                  | $V_{DS} = 20 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $T_j = 125 ^{\circ}\text{C}$ |     |      | 25   |       |
| $I_{D(ON)}$            | $V_{DS} = 10 \text{ V}, V_{DS} = 10 \text{ V}$                                  | 50  |      |      | A     |
| Igss                   | $V_{DS} = \pm 20$   |     |      | ±100 | nA    |
| GFS                    | $V_{DS} = 5 \text{ V}, V_{DS} = 20 \text{ V}$                                   |     | 20   |      | S     |

| Dynamic Characteristics |   |     |      |      |       |
|-------------------------|---|-----|------|------|-------|
| Symbol                  | Test Conditions   | Min | Тур. | Max. | Units |
| $C_{ISS}$               |   |     | 2020 |      | pF    |
| Coss                    | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ $F = 1.0 \text{MHz}$ |     | 275  |      | pF    |
| C <sub>RSS</sub>        | 1' - 1.0MIZ   |     | 160  |      | pF    |



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| Dynamic Characteristics      |  |     |      |      |       |
|------------------------------|--|-----|------|------|-------|
| Symbol                       | Test Conditions  | Min | Typ. | Max. | Units |
| $t_{d(on)}$                  |  |     | 10   |      | ns    |
| t <sub>r</sub>               | $V_{DS} = 150 \text{ V}, I_D = 25 \text{ A},$                          |     | 8    |      | ns    |
| $t_{ m d(off)}$              | $R_G = 2.7 \Omega$ , $V_{GS} = 10 V$<br>$R_D = 0.6 \Omega$             |     | 30   |      | ns    |
| tf                           | 100 010 22   |     | 5    |      | ns    |
| $Q_{\rm g}(V_{\rm GS}=10~V)$ | $V_{DS} = 15 \text{ V}, I_{D} = 25 \text{ A},$ $V_{GS} = 10 \text{ V}$ |     | 23   |      | nC    |
| $Q_{\rm g}(V_{\rm GS}=5~V)$  |  |     | 13   |      | nC    |
| $Q_{\mathrm{gs}}$            |  |     | 4.7  |      | nC    |
| $Q_{\mathrm{gd}}$            |  |     | 7.4  |      | nC    |
| Rg                           | $V_{GS} = 15 \text{ mV}, V_{DS} = 0$ , $f = 1 \text{MHz}$              |     | 1.7  |      | Ω     |

| Source-Drain Diode Characteristics |  |     |      |      |       |
|------------------------------------|--|-----|------|------|-------|
| Symbol                             | Test Conditions                                  | Min | Typ. | Max. | Units |
| Is                                 |  |     |      | 50   | A     |
| Ism                                |  |     |      | 140  |       |
| $V_{SD}$                           | $IF = IS$ , $V_{GS} = 0$ V                       |     |      | 1.3  | V     |
| $t_{rr}$                           |  |     | 22   |      | ns    |
| IRM(REC)                           | $IF = IS$ , $V_{GS} = 0$ V , $dIF/dt=100A/\mu s$ |     | 180  |      | A     |
| Qrr                                |  |     | 12   |      | nC    |

<sup>\*</sup>Pulse Test : Pulse Width ≤300µs, Duty Cycle≤2%



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